

1752-2 1.1

### **Material Composition Declaration**

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**Eclaration** ights reserved under entions. This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

ICP Web Site for information on IPC-1752 Standard http://www.ipc.org/IPC-175x

Form Type\* Distribute Declaration Class\* Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Infomation

Infoliation							
Supplier Information							
Company Unique ID		Response Date*					
00-489-5751	Dun & Bradstreet	Sat, Jul 27, 2013 02:21 AM					
Title - Contact	Phone - Contact *	Email - Contact *					
Product Ecology	801-562-7455	david.lancaster@fairchildsemi.com					
Title - Representative	Phone - Representative *	Email - Representative *					
Product Ecology	801-562-7455	david.lancaster@fairchildsemi.com					
	00-489-5751 Title - Contact Product Ecology Title - Representative	00-489-5751 Dun & Bradstreet   Title - Contact Phone - Contact *   Product Ecology 801-562-7455   Title - Representative Phone - Representative *					

Requester Item Number	m Number Mfr Item Number		Mfr Item Name		Effective Date	Version	P	Manufacturing Site	Weight*	UOM	Unit Type
FAN7602CMX	MX FAN7602CMX		SOIC-8 (AuBW)				INTERNAL PENANG		0.088017	g	Each
Manufacturing Process Information											
Terminal Finish	Base Alloy	J-STD-020 MSL Rating			Peak Process Body Temperature		Max Time at Peak Temperature		No Reflow cycles		
Matte Tin (Sn)	CU Alloy	1			260 C		30 seconds			3	

\* Required Field

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RoHS Material (	Composition Declaration	Declaration Type * Custom							
RoHS Directive 2011/65/EU	RoHS Directive Robinition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Palybrominated Riphenyls (PRR), Polybrominated Diphenyl Ethers (PRDE) and quantity limit of 0.01% by mass (100 PRM) of homogeneous								
restriction of the	Fairchild Semiconductor's statement regarding the directive 2011/65/EU of the European Parliament and of the cou use of certain hazardous substances in electrical and electronic equipment (RoHS Recast). The content of this docun irchild Semiconductor supply chain, manufacturing facilities and affiliates worldwide.								
ensure our production independently ver	The FSC part number listed above and the homogenous materials in the product are compliant with the Directive 2011/65/EU. Fairchild has implemented systems t ensure our products are compliant to environmental regulations and laws worldwide. However, not all materials in Fairchild's products may have been independently verified regarding substance content. In the event of any issues arising from information in this document, the warranty section of Fairchild's standard terms and conditions of sale shall apply, unless alternate contracts have been agreed upon in writing by both parties.								
Safety Data Sheet miniscule quantit	the content disclosed herewith is approximate and is based on various methods including, engineering calculations, its, analytical measurements. Fairchild may update this document without notification. This statement may not including of dopant and metal materials in the electrical devices contained within the finished product. CAS numbers listed contain alternate substances of similar composition.	le information regarding the							
<b>RoHS Declaration</b>	* 1 - Item(s) does not contain RoHS restricted substances per the definition above Sup	plier Acceptance * Accepted							
1 1	ne declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exer ponse in the RoHS Declaration above and choose all applicable exemptions.	nptions, then select the							
Exemption None	List Version EL-2011/534/EU								
Declaration Signa	ature								

David Loncosto

Supplier Signature

DAVID LANCASTER - PRODUCT ECOLOGY MANAGER

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#### Homogeneous Material Composition Declaration for Electronic Products

Item/SubItem Name SOIC-8 (AuBW)

Component	Material	Weight (mg)	Jig Level	Substance Category	Substance	Weight (mg)	CAS	PPM
Chip	Other inorganic materials	7.100	Supplier		Silicon	7.100	7440-21-3	80667
Die Attach	Other Organic Materials	0.718	Supplier		Acrylic Resin	0.154	54208-63-8	1750
			Supplier		Silver	0.564	7440-22-4	6404
Encapsulation	Thermoplastics	39.400	В	Antimony/Antimony Compounds	Antimony Trioxide	0.788	1309-64-4	8953
			В	Brominated Flame Retardants (other than PBCs or PBDEs)	Bromine Resin	0.394	6386-73-8	4476
			Supplier		Carbon Black	0.296	1333-86-4	3357
			Supplier		Epoxy Resin	11.426	29690-82-2	129816
			Supplier		Silica, vitreous	26.496	60676-86-0	301040
Lead Frame	Copper & its alloys	38.600	Supplier		Copper	37.531	7440-50-8	426406
			Supplier		Iron	0.926	7439-89-6	10525
			Supplier		Phosphorus	0.015	7723-14-0	175
			Supplier		Silver	0.077	7440-22-4	877
			Supplier		Zinc	0.050	7440-66-6	570
Plating	Other Nonferrous metals & alloys	2.000	Supplier		Tin	2.000	7440-31-5	22723
Wire Bond	Precious metals	0.199	Supplier		Gold	0.199	7440-57-5	2261

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